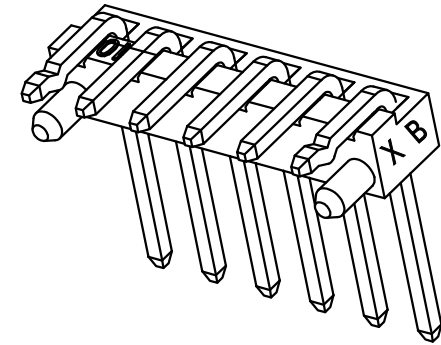
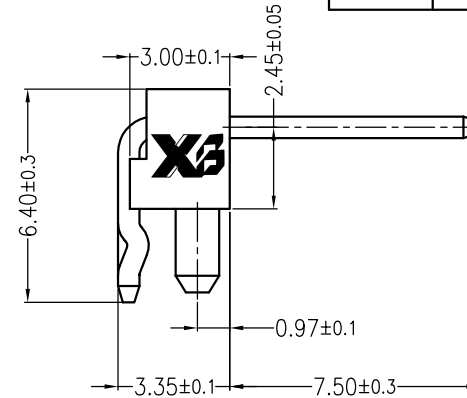
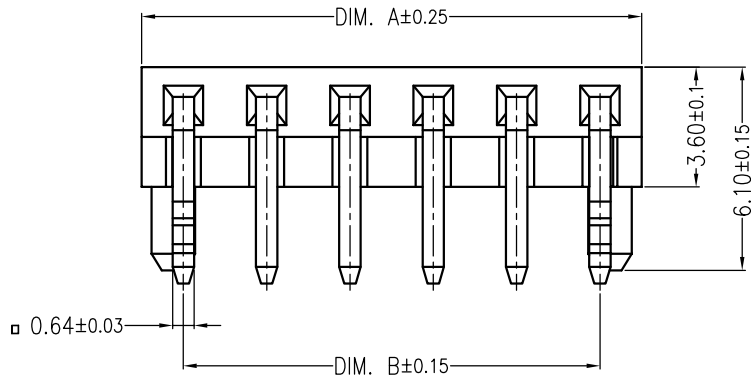
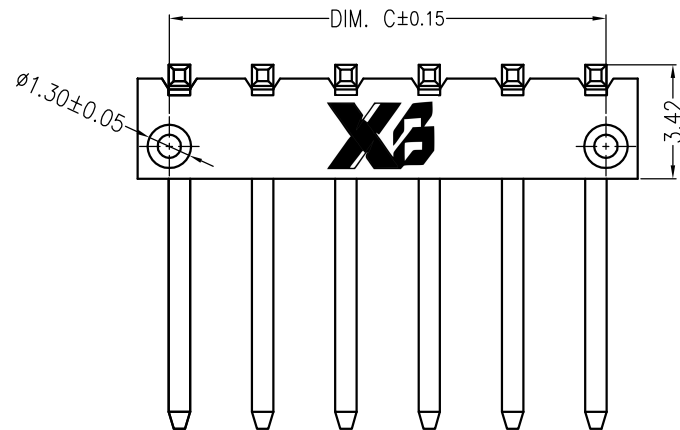


REV	DESCRIPTION	DESIGN	DATE
A0	Release	吴丹平	2016.05.03



主要技术参数 Main Specifications

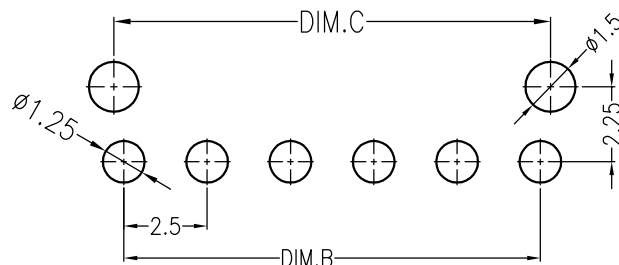
接触电阻 (Contact resistance): $\leq 20m\Omega$
绝缘电阻 (Insulation resistance): $\geq 1000M\Omega$
额定电压 (Rated voltage): 125V AC DC
额定电流 (Rated current): 1.0A AC DC
耐电压 (Withstand Voltage): 1000V AC/minute
温度范围 (Temperature Range): $-40^{\circ}C \sim +130^{\circ}C$



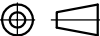
Circuit	Dimensions (mm)		
	DIM. A	DIM. B	DIM. C
02	5.00	2.50	3.10
03	7.50	5.00	5.60
04	10.00	7.50	8.10
05	12.50	10.00	10.60
06	15.00	12.50	13.10

ORDER INFORMATION:

XB-L017A-**-F2MA-P-A		
PART No.		SPECIAL CODE:
No. FOR CIRCUITS:		A=针外露7.5
02~06		PACKAGING:
PLASTIC MATERIAL:		P=PE
F2M=LCP (BEIGE)		PLATING:
		A=Sn



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

C					
B	CONTACT		6 PCS	Brass	Sn-plated
A	PEDESTAL		1 PCS	LCP	UL 94V-0, COLOR:BEIGE
ITEM	COMPONENT		Q'TY	MATERIAL	FINISH
东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO.,LTD			TITLE: - 2.5mmPITCH 90°WAFER SMT TYPE		
X.±0.5	X.±5'	USE: CUSTOMER	PART NO.: L017A-**-F2MA-P-A		
.X±0.3	.X±2'				
.XX±0.25	.XX±1'	APPD: 邵敬和	DWG NO.: GCCP-0033		
--	--	CHKD: 田 峰			
	UNITS: mm	DR: 吴丹平	SCALE 1 : 1		SHEET 1 / 1